

C1812X823K2TACTU

Aliases (C1812X823K2TAC7800)

SMD Comm X8G HT150C Flex, Ceramic, 0.082 uF, 10%, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1812, 2.3 mm



General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	87 mg
Shelf Life	78 Weeks
MSL	1

1812
4.5mm +/-0.4mm
3.2mm +/-0.3mm
2mm +/-0.20mm
2.3mm MIN
0.7mm +/-0.35mm

Т	2mm +/-0.20mm
S	2.3mm MIN
В	0.7mm +/-0.35mm
Designing Considerations	
Packaging Specifications	

Specifications	
Capacitance	0.082 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	12.1951 GOhms

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	500

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